

Features

- Top view 0603 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Yellow Green
- RoHS compliance

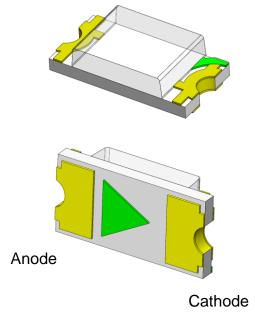
Applications

- Optical indicator.
- Switch and Symbol Display.

Description

The YGP160804-CTC4 is an AlGaInP Yellow Green LED housed in a miniature SMD package. The device has a dominant wavelength of 570nm LED.

Package Outline



Schematic

Cathode
$$\longrightarrow$$
 Anode $(-)$



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l _F	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	60	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =5mA	7.2	-	28.5	mcd	3
λр	Peak Wavelength	I _F =5mA	-	575	-	nm	
λd	Dominant Wavelength	I _F =5mA	567.5	-	575.5	nm	4
θ1/2	Angle of Half Intensity	I _F =5mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =5mA	1.75	-	2.35	V	5
I _R	Reverse Current	V _R =5V	-	-	1	μΑ	

Notes:

- 1. I_{FP} Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
K	7.2	11.5		
L	11.5	18.0	mcd	I _F =5mA
М	18.0	28.5		

Tolerance of: Luminous Intensity $\pm 10\%$



4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition	
AG15	567.5	569.5		I _F =5mA	
AG16	569.5	571.5			
AG17	571.5	573.5	nm		
AG18	573.5	575.5			

Tolerance of Dominant Wavelength: $\pm 1\,\text{nm}$.

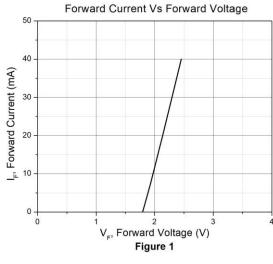
5. Bin Range of Forward Voltage

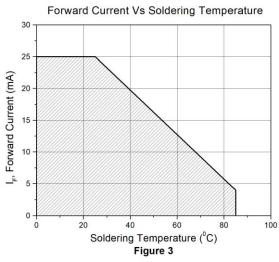
Bin Code	Min	Max	Unit	Condition
0	1.75	1.95		
1	1.95	2.15	V	I _F =5mA
2	2.15	2.35		

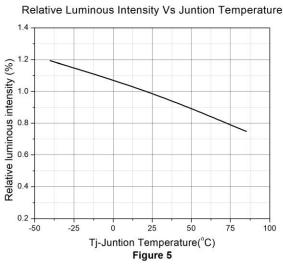
Tolerance of Forward Voltage ± 0.1 V.

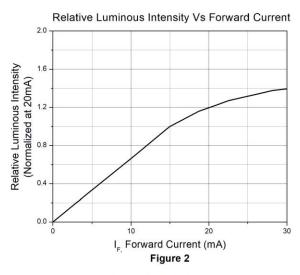


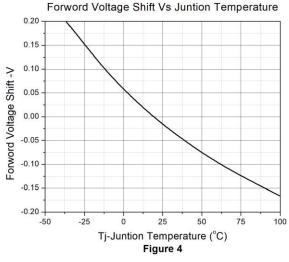
Typical Characteristic Curves

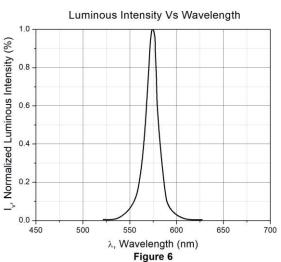






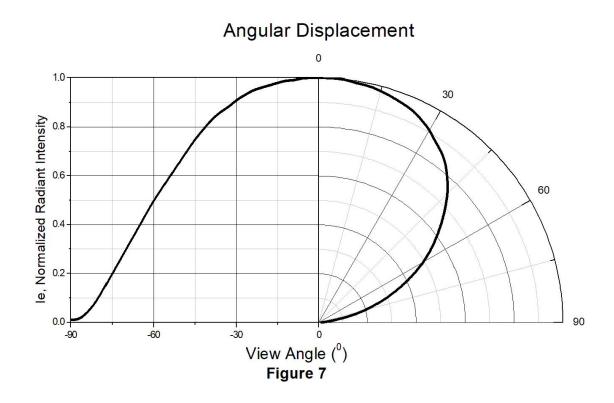






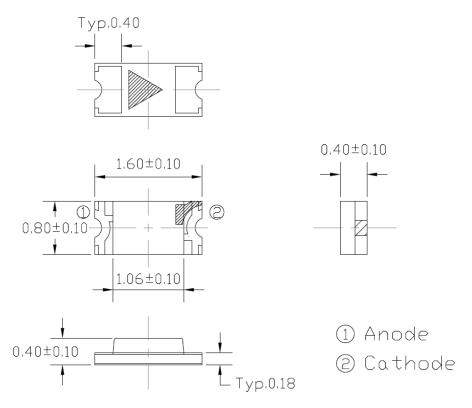


Typical Characteristic Curves



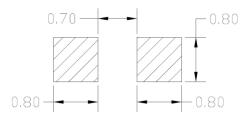


Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



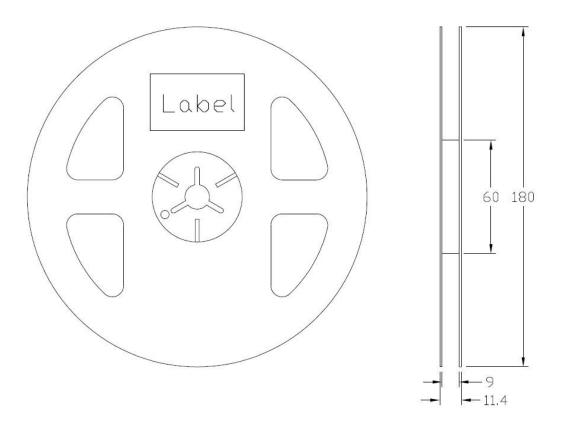
Note: Tolerance unless mentioned is ±0.1mm.

Ordering Information

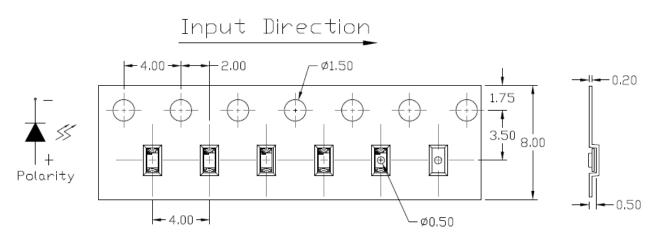
Part Number	Description	Quantity
YGP160804-CTC4	Tape & Reel	4000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



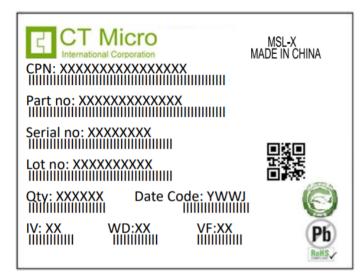
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

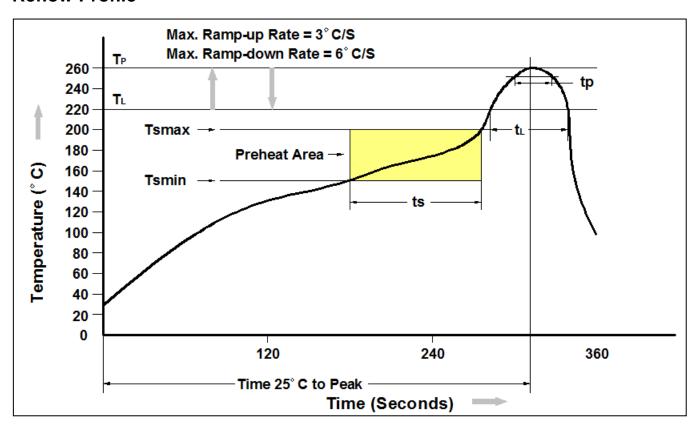
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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